

N-CHANNEL 650V - 1.5Ω - 5A TO-220 Zener-Protected SuperMESH[™]Power MOSFET

ТҮРЕ	V _{DSS}	R _{DS(on)}	ID	Pw
STP5NK65Z	650 V	< 1.8 Ω	5 A	85 W

- TYPICAL $R_{DS}(on) = 1.5 \Omega$
- EXTREMELY HIGH dv/dt CAPABILITY
- IMPROVED ESD CAPABILITY
- 100% AVALANCHE RATED
- GATE CHARGE MINIMIZED
- VERY LOW INTRINSIC CAPACITANCES
- VERY GOOD MANUFACTURING REPEATIBILITY

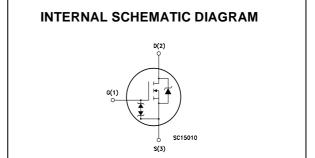
DESCRIPTION

The SuperMESH[™] series is obtained through an extreme optimization of ST's well established stripbased PowerMESH[™] layout. In addition to pushing on-resistance significantly down, special care is taken to ensure a very good dv/dt capability for the most demanding applications. Such series complements ST full range of high voltage MOSFETs including revolutionary MDmesh[™] products.

APPLICATIONS

- HIGH CURRENT, HIGH SPEED SWITCHING
- IDEAL FOR OFF-LINE POWER SUPPLIES, ADAPTORS AND PFC

СССС 123 TO-220



ORDERING INFORMATION

SALES TYPE	MARKING	PACKAGE	PACKAGING
STP5NK65Z	P5NK65Z	TO-220	TUBE

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source Voltage ($V_{GS} = 0$)	650	V
V _{DGR}	Drain-gate Voltage ($R_{GS} = 20 \text{ k}\Omega$)	650	V
V _{GS}	Gate- source Voltage	± 30	V
I _D	Drain Current (continuous) at $T_C = 25^{\circ}C$	5	Α
ID	Drain Current (continuous) at $T_C = 100^{\circ}C$	3.1	А
I _{DM} (•)	Drain Current (pulsed)	20	A
P _{TOT}	Total Dissipation at $T_C = 25^{\circ}C$	85	W
	Derating Factor	0.6	W/°C
V _{ESD(G-S)}	Gate source ESD(HBM-C=100pF, R=1.5KΩ)	2000	V
dv/dt (1)	Peak Diode Recovery voltage slope	4.5	V/ns
T _j T _{stg}	Operating Junction Temperature Storage Temperature	-55 to 150 -55 to 150	°C ℃

(•) Pulse width limited by safe operating area

(1) $I_{SD} \le 5A$, di/dt $\le 100 \ \mu A$, $V_{DD} \le V_{(BR)DSS}$, $T_j \le T_{JMAX}$.

(*) Limited only by maximum temperature allowed

THERMAL DATA

Rthj-case	Thermal Resistance Junction-case Max	1.64	°C/W
Rthj-amb	Thermal Resistance Junction-ambient Max	50	°C/W
TI	Maximum Lead Temperature For Soldering Purpose	300	°C

AVALANCHE CHARACTERISTICS

Symbol	Parameter	Max Value	Unit
I _{AR}	Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by T_j max)	4.2	A
E _{AS}	Single Pulse Avalanche Energy (starting $T_j = 25 \text{ °C}$, $I_D = I_{AR}$, $V_{DD} = 50 \text{ V}$)	190	mJ

GATE-SOURCE ZENER DIODE

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
BV _{GSO}	Gate-Source Breakdown Voltage	lgs=± 1mA (Open Drain)	30			V

PROTECTION FEATURES OF GATE-TO-SOURCE ZENER DIODES

The built-in back-to-back Zener diodes have specifically been designed to enhance not only the device's ESD capability, but also to make them safely absorb possible voltage transients that may occasionally be applied from gate to souce. In this respect the Zener voltage is appropriate to achieve an efficient and cost-effective intervention to protect the device's integrity. These integrated Zener diodes thus avoid the usage of external components.

ELECTRICAL CHARACTERISTICS (TCASE =25°C UNLESS OTHERWISE SPECIFIED) ON/OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _(BR) DSS	Drain-source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0	650			V
I _{DSS}	Zero Gate Voltage Drain Current (V _{GS} = 0)	V _{DS} = Max Rating V _{DS} = Max Rating, T _C = 125 °C			1 50	μΑ μΑ
I _{GSS}	Gate-body Leakage Current (V _{DS} = 0)	$V_{GS} = \pm 20V$			±10	μA
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 50 \mu A$	3	3.75	4.5	V
R _{DS(on)}	Static Drain-source On Resistance	V _{GS} = 10V, I _D = 2.1 A		1.5	1.8	Ω

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
g _{fs} (1)	Forward Transconductance	V _{DS} = 10 V, I _D = 2.1 A		5		S
C _{iss} C _{oss} C _{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	V _{DS} = 25V, f = 1 MHz, V _{GS} = 0		680 80 17		pF pF pF
C _{oss eq.} (3)	Equivalent Output Capacitance	$V_{GS} = 0V, V_{DS} = 0V$ to 480 V		98		pF

SWITCHING ON

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r	Turn-on Delay Time Rise Time	$\label{eq:VDD} \begin{array}{l} V_{DD} = 325 \ \text{V}, \ \text{I}_{D} = 2.1 \ \text{A} \\ R_{G} = 4.7\Omega \ \text{V}_{GS} = 10 \ \text{V} \\ (\text{Resistive Load see, Figure 3}) \end{array}$		20 15		ns ns
Q _g Q _{gs} Q _{gd}	Total Gate Charge Gate-Source Charge Gate-Drain Charge	$V_{DD} = 520V, I_D = 4.2 \text{ A}, V_{GS} = 10V$		25 4.4 13.7	35	nC nC nC

SWITCHING OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(off)} t _f	Turn-off Delay Time Fall Time	$ \begin{array}{l} V_{DD} = 325 \; V, \; I_D = 2.1 \; A \\ R_G = 4.7 \Omega \; V_GS = 10 \; V \\ (Resistive Load see, Figure 3) \end{array} $		140 40		ns ns
t _{r(Voff)} t _f t _C	Off-voltage Rise Time Fall Time Cross-over Time	$\label{eq:VDD} \begin{array}{l} V_{DD} = 520 \; V, \; I_D = 4.2 \; A, \\ R_G = 4.7\Omega, \; V_GS = 10V \\ (Inductive Load see, Figure 5) \end{array}$		12 7 15		ns ns ns

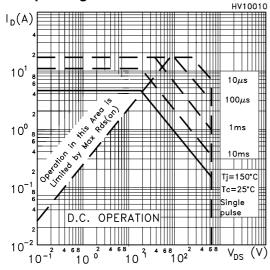
SOURCE DRAIN DIODE

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I _{SD} I _{SDM} (2)	Source-drain Current Source-drain Current (pulsed)				5 20	A A
V _{SD} (1)	Forward On Voltage	$I_{SD} = 5 \text{ A}, V_{GS} = 0$			1.6	V
t _{rr} Q _{rr} I _{RRM}	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	I_{SD} = 4.2 A, di/dt = 100A/µs V _{DD} = 100V, T _j = 150°C (see test circuit, Figure 5)		375 1.76 10		ns μC Α

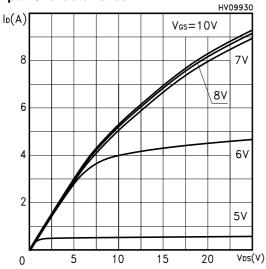
Note: 1. Pulsed: Pulse duration = $300 \mu s$, duty cycle 1.5 %.

Label Fulse duration = 500 µs, duty cycle 1.5 %.
Pulse width limited by safe operating area.
C_{oss eq.} is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}.

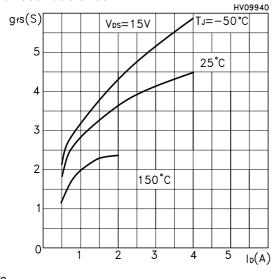
Safe Operating Area



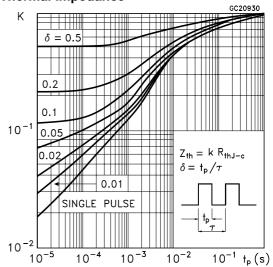
Output Characteristics



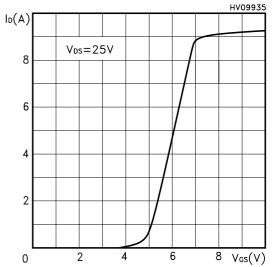
Transconductance



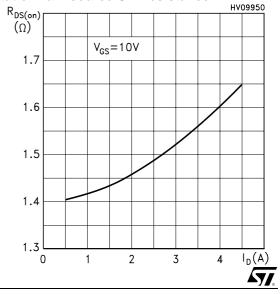
Thermal Impedance

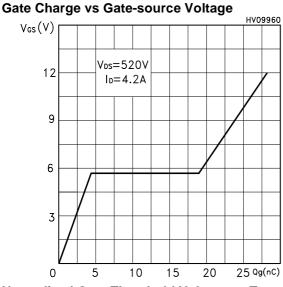


Transfer Characteristics

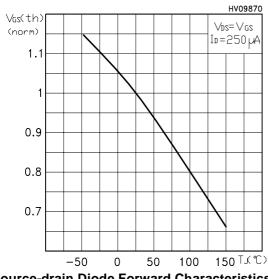


Static Drain-source On Resistance

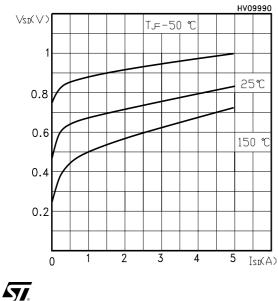




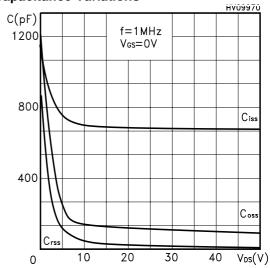
Normalized Gate Threshold Voltage vs Temp.



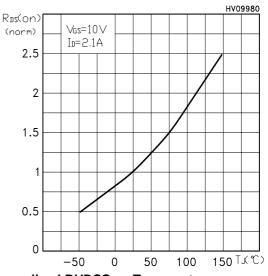




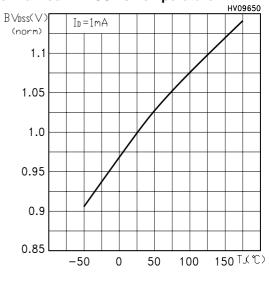
Capacitance Variations

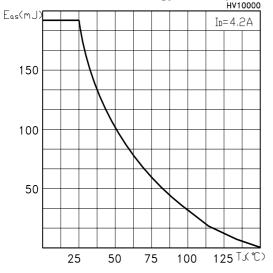


Normalized On Resistance vs Temperature



Normalized BVDSS vs Temperature





Maximum Avalanche Energy vs Temperature

Fig. 1: Unclamped Inductive Load Test Circuit

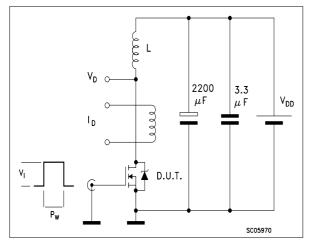


Fig. 3: Switching Times Test Circuit For Resistive Load

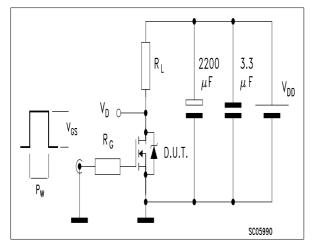


Fig. 5: Test Circuit For Inductive Load Switching And Diode Recovery Times

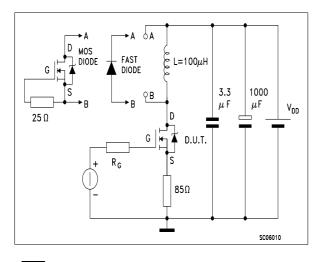


Fig. 2: Unclamped Inductive Waveform

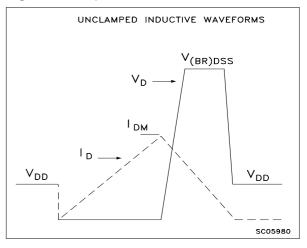
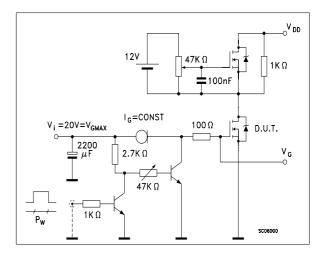
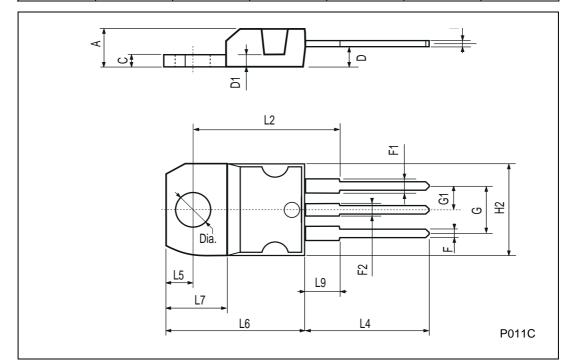


Fig. 4: Gate Charge test Circuit



DIM.		mm		inch			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	4.40		4.60	0.173		0.181	
С	1.23		1.32	0.048		0.051	
D	2.40		2.72	0.094		0.107	
D1		1.27			0.050		
E	0.49		0.70	0.019		0.027	
F	0.61		0.88	0.024		0.034	
F1	1.14		1.70	0.044		0.067	
F2	1.14		1.70	0.044		0.067	
G	4.95		5.15	0.194		0.203	
G1	2.4		2.7	0.094		0.106	
H2	10.0		10.40	0.393		0.409	
L2		16.4			0.645		
L4	13.0		14.0	0.511		0.551	
L5	2.65		2.95	0.104		0.116	
L6	15.25		15.75	0.600		0.620	
L7	6.2		6.6	0.244		0.260	
L9	3.5		3.93	0.137		0.154	
DIA.	3.75		3.85	0.147		0.151	

TO-220 MECHANICAL DATA



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